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PATENT

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**LOW VOC-SOLVENT BASED MOLD RELEASE AGENT AND  
CURABLE MOLD RELEASE COMPOSITIONS BASED THEREON**

**ABSTRACT**

The present invention relates to curable mold release compositions containing a non-volatile organic (non-VOC), or low-volatile organic (low-VOC), component employed as a carrier for a curable component. When applied as a coating the mold release compositions cure to a finish having a high durability that is sustained throughout multiple releases.